MSF6N90

N-Channel 900V MOSFET

Description

The MS6N90 is a N-channel enhancement-mode MOSFET, providing the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness. The ITO-220AB package is universally preferred for all commercial-industrial applications

Features

- RDS(on) (Max 2.4 Ω)@VGS=10V
- Gate Charge (Typical 33nC)
- Improved dv/dt Capability, High Ruggedness
- 100% Avalanche Tested
- Maximum Junction Temperature Range (150˚C)
- RoHS compliant package

Application

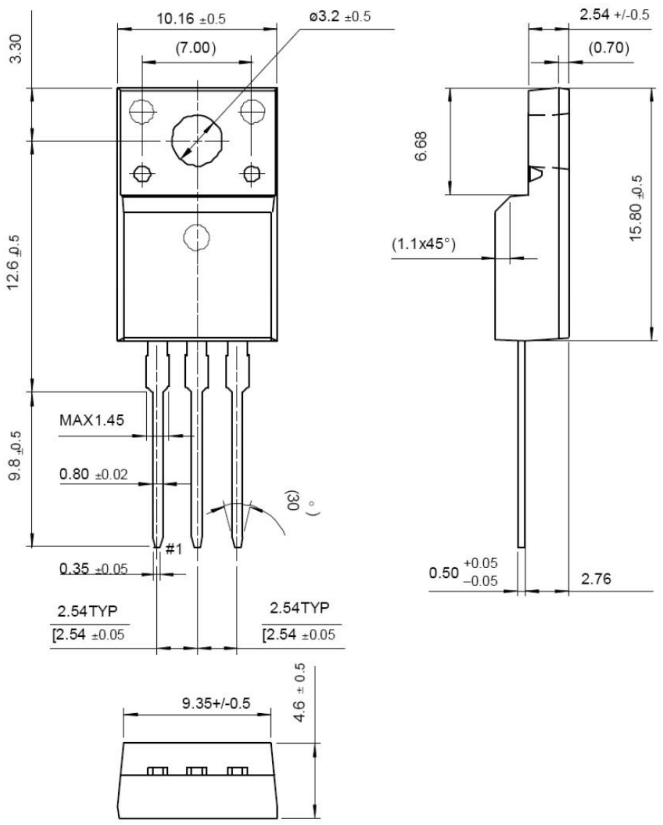
- Power Factor Correction
- LCD TV Power
- Full and Half Bridge Power

Package type：ITO-220AB

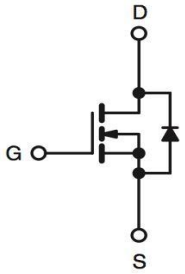
Packing & Order Information

50/Tube ; 1,000/Box

RoHS COMPLIANT



Graphic symbol



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage	900	V
V_{GS}	Gate-Source Voltage	±30	V
I_D	Drain Current -Continuous (TC=25°C)	6	A
	Drain Current -Continuous (TC=100°C)	3.8	A
I_{DM}	Drain Current Pulsed	24	A
E_{AS}	Single Pulsed Avalanche Energy	650	mJ
E_{AR}	Repetitive Avalanche Energy	16.7	mJ
dv/dt	Peak Diode Recovery dv/dt	4.5	V/ns

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Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
P_D	Total Power Dissipation (TC = 25 °C)	56	W
	Derating Factor above 25 °C	0.48	W/°C
T_J,T_{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C

• Drain current limited by maximum junction temperature

Thermal characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Max.	Units
$R_{\theta JC}$	Junction-to-Case	2.25	°C/W
$R_{\theta JA}$	Junction-to-Ambient	62.5	

On Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
V_{GS}	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250μA	3.0	--	5.0	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V,I_D=3A	--	1.95	2.4	Ω

Off Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0 V , I_D=250μA	900	--	--	V
ΔBV_{DSS} /ΔT_J	Breakdown Voltage Temperature Coefficient	I_D=250μA, Referenced to 25°C	--	1.03	--	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=900V , V_{GS}= 0 V V_{DS}=720V , T_C= 125°C	--	--	10 100	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	V_{GS}=30V , V_{DS}=0 V	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS}=-30V , V_{DS}=0 V	--	--	-100	nA

Dynamic Characteristics

Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
C_{ISS}	Input Capacitance	V_{DS}=25V, V_{GS}=0V, f=1.0MHz	--	1500	2010	pF
C_{OSS}	Output Capacitance		--	145	190	pF
C_{RSS}	Reverse Transfer Capacitance		--	15	20	pF

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Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Time	V_{DS}=450 V, I_D=6A, R_G=25Ω	--	40	80	ns
t_r	Turn-On Time		--	120	240	ns
$t_{d(off)}$	Turn-Off Delay Time		--	60	120	ns
tf	Turn-Off Fall Time		--	70	140	ns
Q_g	Total Gate Charge	V_{DS}=720V, I_D=6A, V_{GS}=10 V	--	33	45	nC
Q_{gs}	Gate-Source Charge		--	10	--	nC
Q_{gd}	Gate-Drain Charge		--	13	--	nC

Source-Drain Diode Maximum Ratings and Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
I_S	Continuous Source-Drain Diode Forward Current		--	--	6.0	A
I_{SM}	ISM Pulsed Source-Drain Diode Forward Current		--	--	24.0	
V_{SD}	Source-Drain Diode Forward Voltage	I_S=6A , V_{GS}= 0V	--	--	1.4	V
t_{rr}	Reverse Recovery Time	I_S=6A , V_{GS}= 0V diF/dt=100A/μs	--	780	--	ns
Q_{rr}	Reverse Recovery Charge		--	9.0	--	μC

Notes;

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L=34mH, I_{AS}=6A, V_{DD}=50V, R_G=25Ω, Starting T_J=25℃
3. I_{SD}≦6A, di/dt≦200A/μs, V_{DD}≦BV_{DSS}, Starting T_J=25℃
4. Pulse Test: Pulse Width ≦ 300μs, Duty Cycle≦ 2%
5. Essentially Independent of Operating Temperature

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■Characteristics Curve

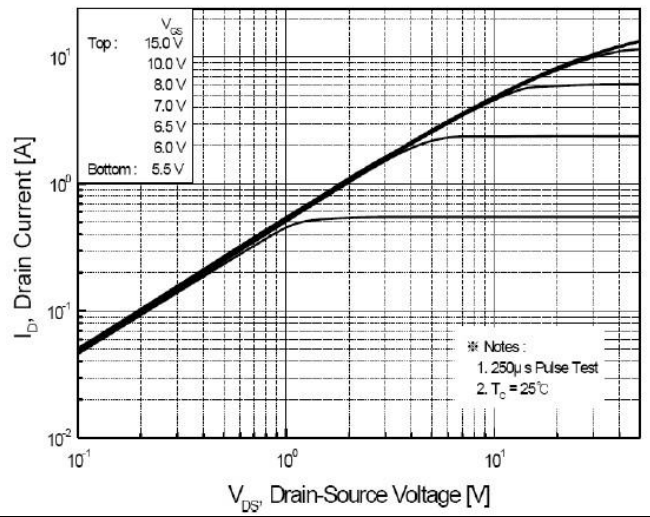

FIG.1-ON REGION CHARACTERISTICS

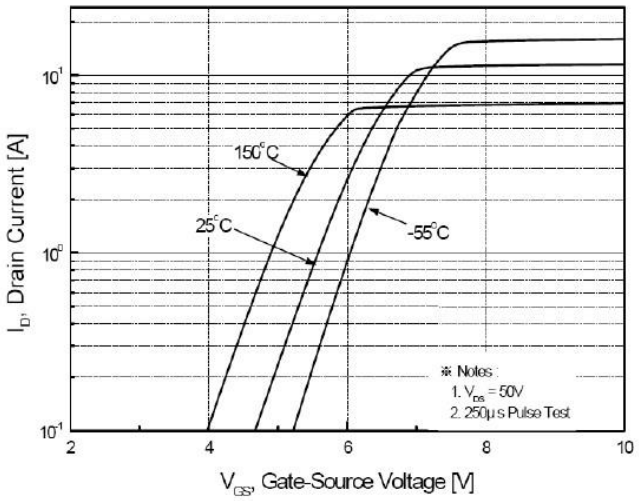

FIG.2-TRANSFER CHARACTERISTICS

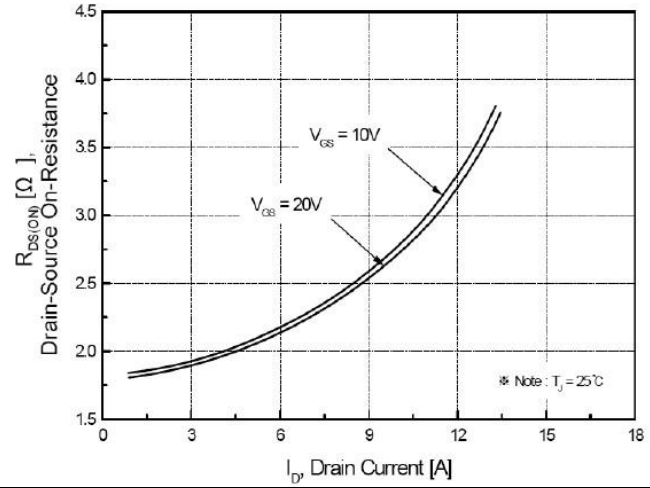

FIG.3-ON RESISTANCE VARIATION VS DRAIN CURRENT AND GATE VOLTAGE

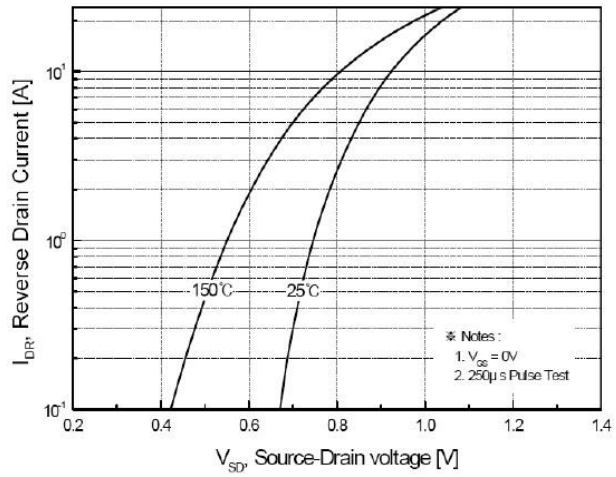

FIG.4-BODY DIODE FORWARD VOLTAGE VARIATION WITH SOURCE CURRENT AND TEMPERATURE

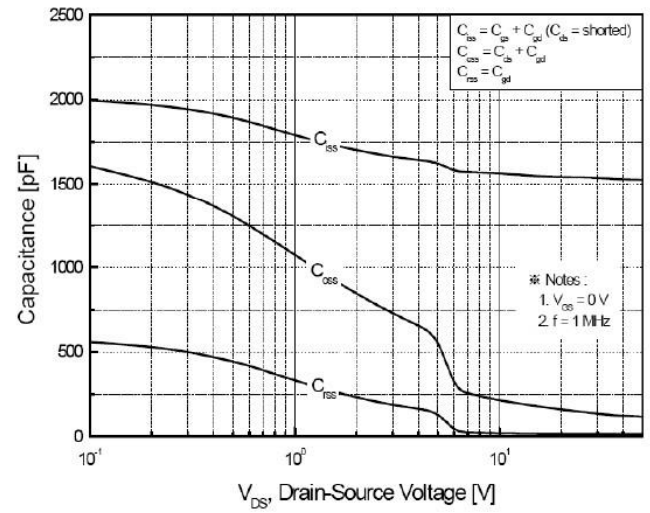

FIG.5-CAPACITANCE CHARACTERISTICS

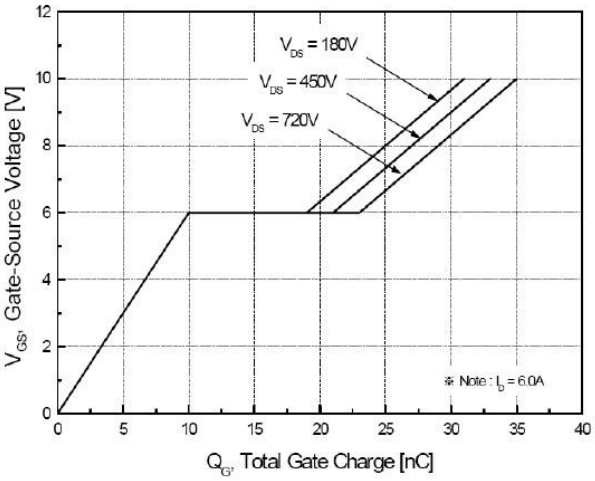

FIG.6-GATE CHARGE CHARACTERISTICS

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■Characteristics Curve

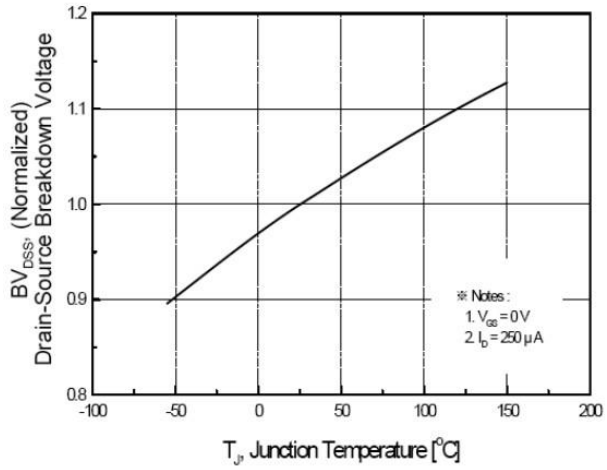

FIG.7-BREAKDOWN VOLTAGE VARIATION VS TEMPERATURE

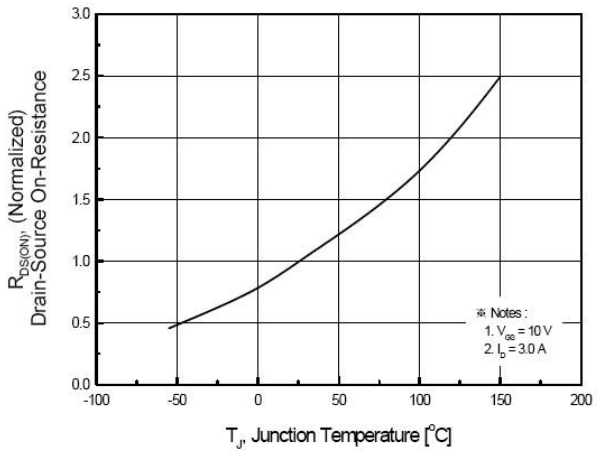

FIG.8-ON-RESISTANCE VARIATION VS TEMPERATURE

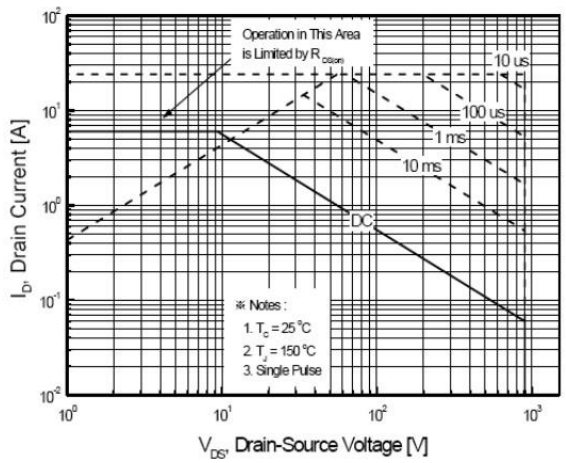

FIG.9-MAXIMUM SAFE OPERATING AREA

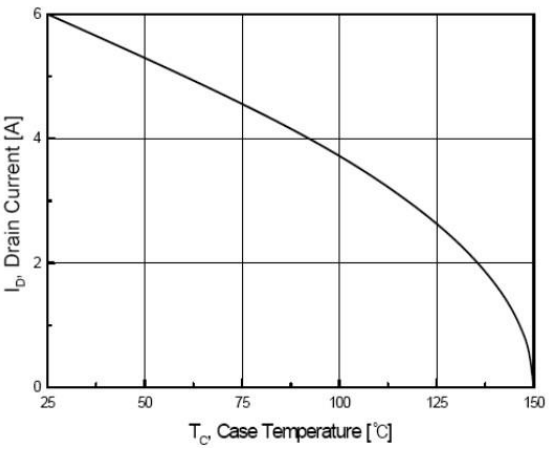

FIG.10-MAXIMUM DRAIN CURRENT VS CASE TEMPERATURE

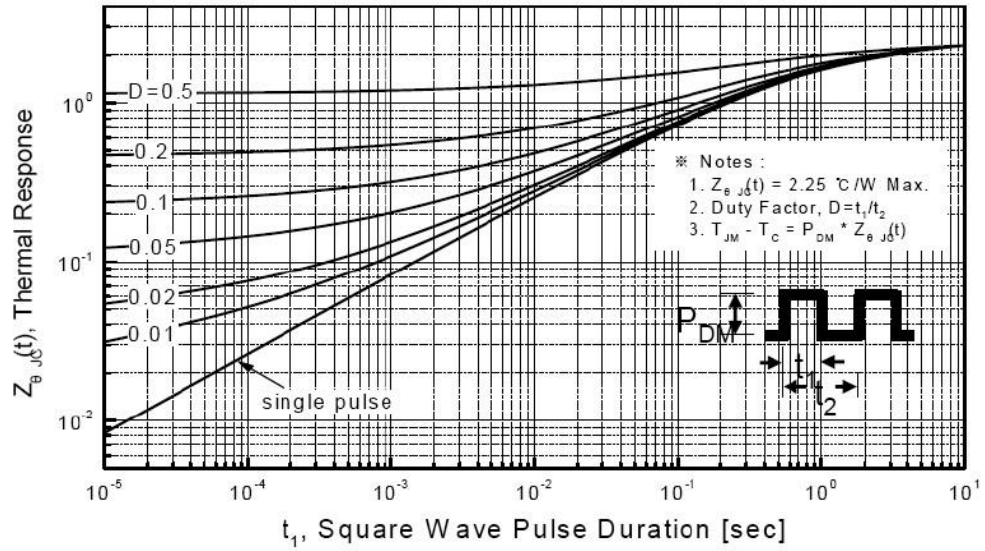

FIG.11-TRANSIENT THERMAL RESPONSE CURVE

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■Characteristics Test Circuit & Waveform

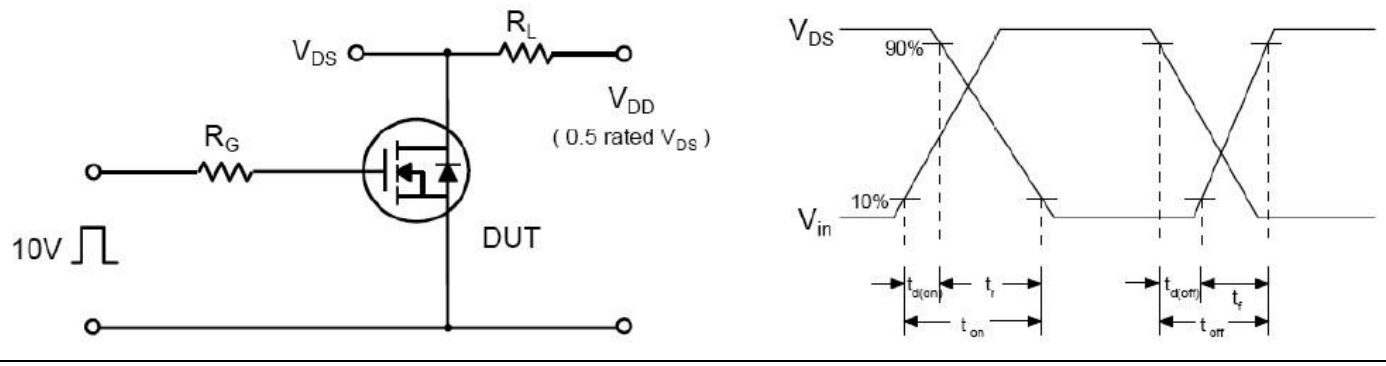

Fig 12. Resistive Switching Test Circuit & Waveforms

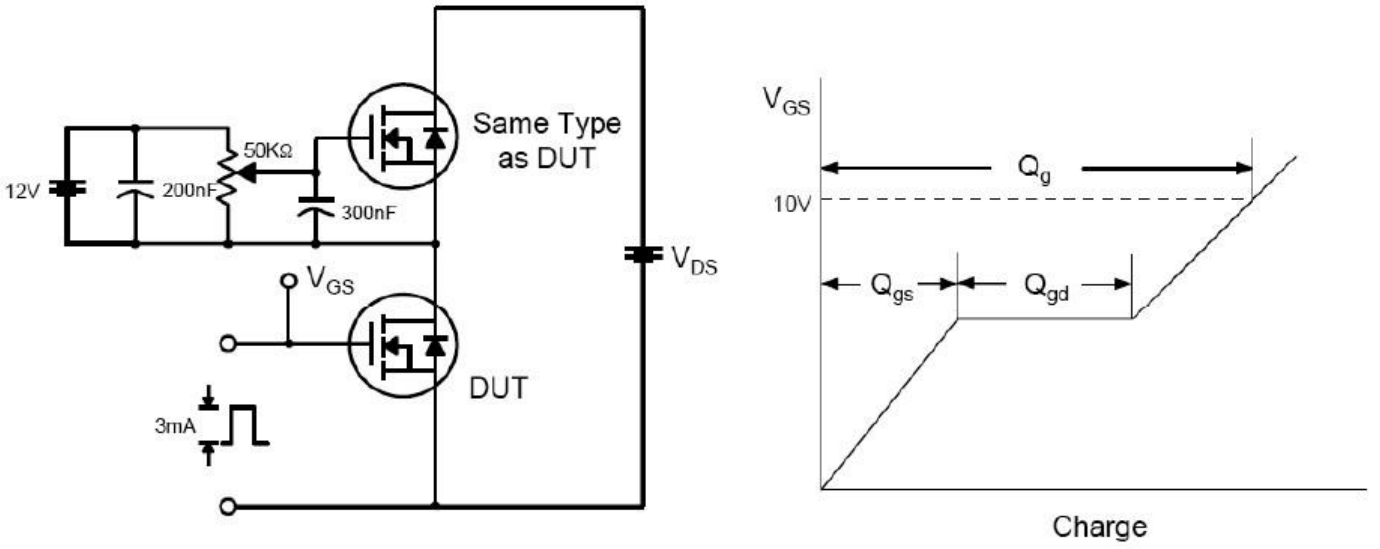

Fig 13. Gate Charge Test Circuit & Waveform

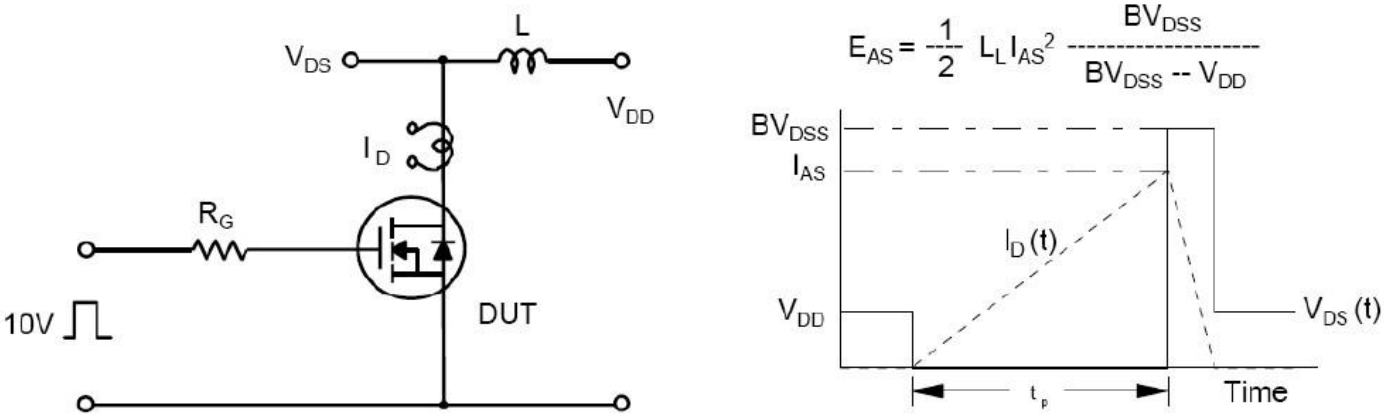

Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

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